Unit: mm

TOSHIBA Photocoupler Photorelay

# **TLP222G, TLP222G-2**

Cordless Telephones PBX Modems

The Toshiba TLP222G series consist of a gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a DIP package.

The TLP222G series are a bi-directional switch, which can replace mechanical relays in many applications.

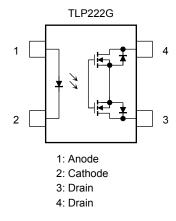
- TLP222G: 4-pin DIP (DIP4), 1-channel type (1-form-A)
- TLP222G-2: 8-pin DIP (DIP8), 2-channel type (2-form-A)
- Peak Off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance:  $35 \Omega$  (max, t < 1 s)
- On-state resistance: 50 Ω (max, continuous)
- Isolation voltage: 2500 Vrms (min)
- UL approved: UL1577, File No.E67349
- cUL approved :CSA Component Acceptance Service

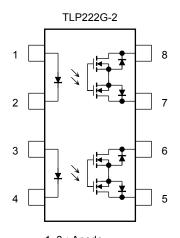
No. 5A, File No.E67349

# 1.2 ± 0.15 0.5 ± 0.1 2.54 ± 0.25 7.85 ~ 8.80 TOSHIBA 11-5B2

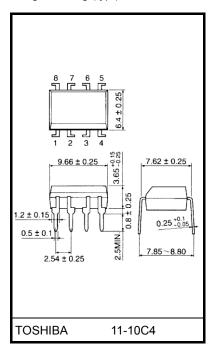
Weight: 0.26 g (typ.)

#### Pin Configuration (top view)





1, 3 : Anode 2, 4 : Cathode 5 : Drain D1 6 : Drain D2 7 : Drain D3 8 : Drain D4



Weight: 0.54 g (typ.)

Start of commercial production 2001-12

#### Absolute Maximum Rating (Ta = 25°C)

	(	Characteristics	Symbol	Rating	Unit		
	Forward curr	ent		ΙF	50	mA	
	Forward curr	ent derating (	Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C	
	Peak forward	d current (10	00 μs pulse, 100 pps)	IFP	1	Α	
LED	Reverse volt	age		V <sub>R</sub>	5	V	
	Diode power	dissipation		$P_D$	50	mW	
	Diode power	dissipation d	erating (Ta ≥ 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C	
	Junction tem	perature		Tj	125	°C	
	Off-state out	put terminal v	oltage	V <sub>OFF</sub>	350	V	
		TLP222G					
	On-state current	TLP222G-2	One channel operation	I <sub>ON</sub>	120	mA	
			Two channel operations				
<b>.</b>	On-state current derating (Ta ≥ 25°C)	TLP222G					
Detector		TLP222G-2	One channel operation	Δl <sub>ON</sub> /°C	-1.2	mA/°C	
		TLF 222G-2	Two channel operations				
	Output power	r dissipation		Po	450	mW	
	Output powe	r dissipation o	derating (Ta ≥ 25°C)	ΔP <sub>O</sub> /°C	-4.5	mW / °C	
	Junction tem	perature		Tj	125	°C	
Storage to	emperature ra	inge	T <sub>stg</sub>	−55 to 125	°C		
Operating	temperature	range	T <sub>opr</sub>	−40 to 85	°C		
Lead solo	lering tempera	ature (10 s)	T <sub>sol</sub>	260	°C		
Isolation	voltage (AC, 1	minute, R.H.	BVS	2500	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together and detector side pins shorted together.

#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	lF	5	7.5	25	mA
On-state current	I <sub>ON</sub>	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	C <sub>T</sub>	VF = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l <sub>OFF</sub>	V <sub>OFF</sub> = 350 V	_	_	1	μА
	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 1 MHz	-	30	_	pF

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# **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	_	1	3	mA
Return LED current	I <sub>FC</sub>	I <sub>OFF</sub> = 100 μA	0.1		_	mA
		$I_{ON} = 120 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$		25	35	
On-state resistance		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, continuous (Note)		35	50	Ω

Note: Continuous means a state of thermally saturated.

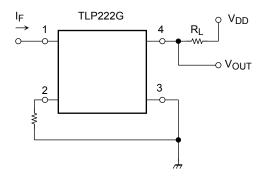
# **Isolation Characteristics (Ta = 25°C)**

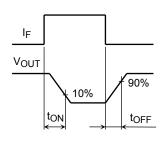
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	2500	_	_	Vrms
Isolation voltage	$BV_S$	AC, 1 second, in oil	_	5000	_	
		DC, 1 minute, in oil	_	5000	_	Vdc

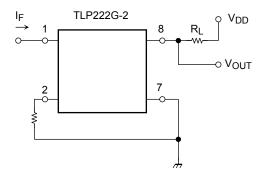
# **Switching Characteristics (Ta = 25°C)**

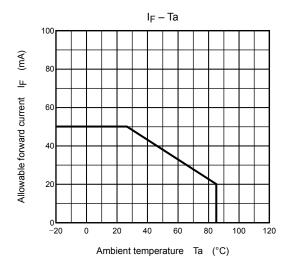
Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	$R_L = 200 \Omega$		_	0.3	1	mo
Turn-off time	t <sub>OFF</sub>	$V_{DD}^{-} = 20 \text{ V, I}_{F} = 5 \text{ mA}$ (N	ote)	_	0.1	1	ms

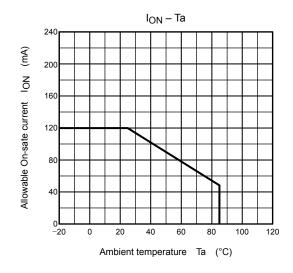
Note: Switching time test circuit

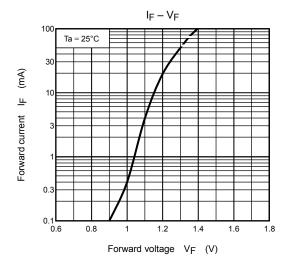


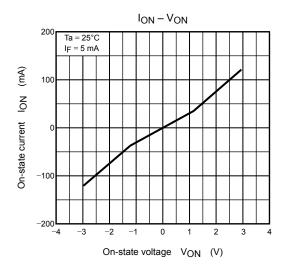


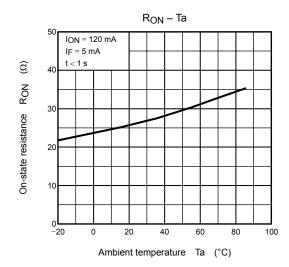


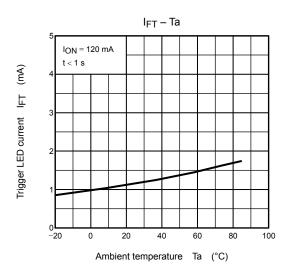




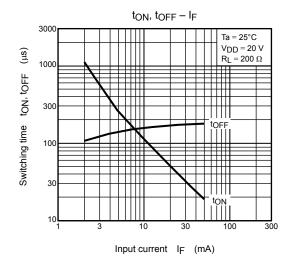


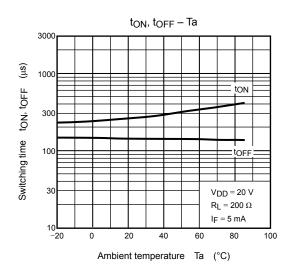


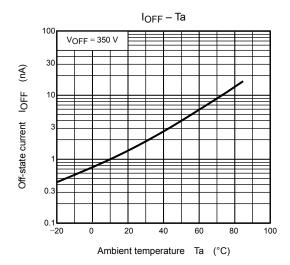




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